

Ultrasonic Systems, Inc.

Coating Systems



Company History

- Founded in 1989 with over 2,500 ultrasonic coating systems installed worldwide in the electronics assembly market
- Developed proprietary "nozzle-less" ultrasonic spray coating technology
- Multiple applications including:
 - Fuel Cell
 - Solar
 - Electronics Assembly
 - Display
 - Semiconductor Packaging
 - LED Manufacture
 - Medical
 - Batteries
 - Specialty

The ultimate coverage in coating systems



EMI Shielding Requirement

- EMI shielding is increasingly important
 - highly sensitive components more tightly packed in circuit assemblies
 - prevent EMI interference between components
 - · minimizing thickness of EMI shield layer critically important
- Traditional methods to apply EMI shield layer
 - sputtering
 - plating
 - layer thickness 3 to 6 µm has proven effective
 - · complex application process
 - substantial process cost
- New EMI shield coating materials
 - · recently developed
 - applied by much simpler and cost effective ultra-thin Coating Application Technology (T-CAT)
- T-CAT Application Process
 - · "nozzle-less" ultrasonic spray technology
 - · precision coating system platform
 - same EMI shield performance as traditional methods
 - reduces process cost by up to 60%